

RJK03E9DPA

Silicon N Channel Power MOS FET Power Switching

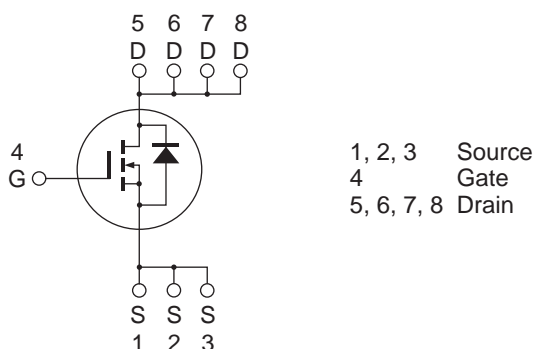
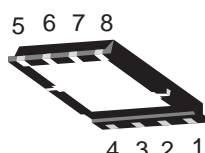
REJ03G1933-0210
Rev.2.10
May 20, 2010

Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
 $R_{DS(on)} = 3.5 \text{ m}\Omega$ typ. (at $V_{GS} = 8 \text{ V}$)
- Pb-free
- Halogen-free

Outline

RENESAS Package code: PWSN0008DC-A
(Package name: WPAK(2))



Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	± 12	V
Drain current	I_D	35	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	140	A
Body-drain diode reverse drain current	I_{DR}	35	A
Avalanche current	I_{AP} ^{Note 2}	16	A
Avalanche energy	E_{AR} ^{Note 2}	25.6	mJ
Channel dissipation	P_{ch} ^{Note 3}	35	W
Channel to case thermal impedance	θ_{ch-c} ^{Note 3}	3.57	$^\circ\text{C}/\text{W}$
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$
2. Value at $T_{ch} = 25^\circ\text{C}$, $R_g \geq 50 \Omega$
3. $T_c = 25^\circ\text{C}$

Electrical Characteristics

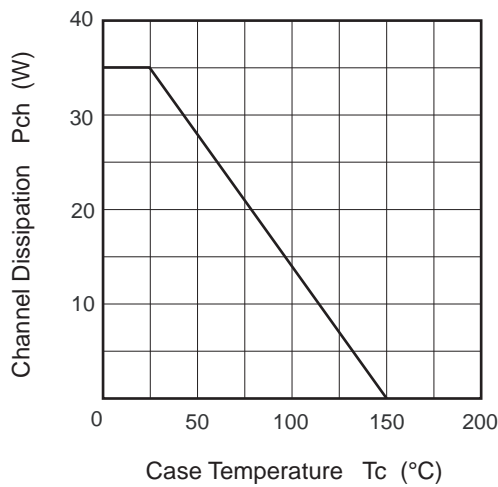
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 12 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.2	—	2.5	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	3.5	4.3	$\text{m}\Omega$	$I_D = 17.5 \text{ A}$, $V_{GS} = 8.0 \text{ V}$ ^{Note4}
	$R_{DS(on)}$	—	4.3	5.4	$\text{m}\Omega$	$I_D = 17.5 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note4}
Forward transfer admittance	$ y_{fs} $	—	95	—	S	$I_D = 17.5 \text{ A}$, $V_{DS} = 5 \text{ V}$ ^{Note4}
Input capacitance	C_{iss}	—	3100	4340	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	320	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	193	—	pF	$f = 1 \text{ MHz}$
Gate Resistance	R_g	—	1.2	2.4	Ω	
Total gate charge	Q_g	—	22	—	nC	$V_{DD} = 10 \text{ V}$
Gate to source charge	Q_{gs}	—	8.6	—	nC	$V_{GS} = 4.5 \text{ V}$
Gate to drain charge	Q_{gd}	—	5.7	—	nC	$I_D = 35 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	16	—	ns	$V_{GS} = 8 \text{ V}$, $I_D = 17.5 \text{ A}$
Rise time	t_r	—	5.3	—	ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	51	—	ns	$R_L = 0.57 \Omega$
Fall time	t_f	—	8.2	—	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	V_{DF}	—	0.83	1.08	V	$I_F = 35 \text{ A}$, $V_{GS} = 0$ ^{Note4}
Body-drain diode reverse recovery time	t_{rr}	—	19	—	ns	$I_F = 35 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 100 \text{ A}/\mu\text{s}$

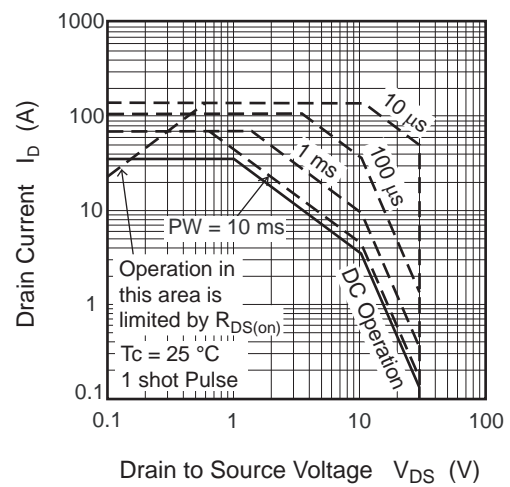
Notes: 4. Pulse test

Main Characteristics

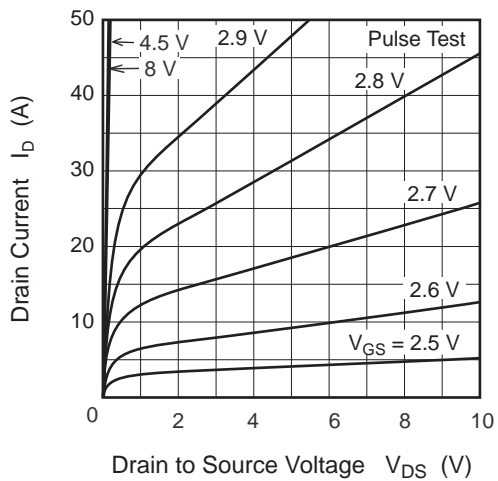
Power vs. Temperature Derating



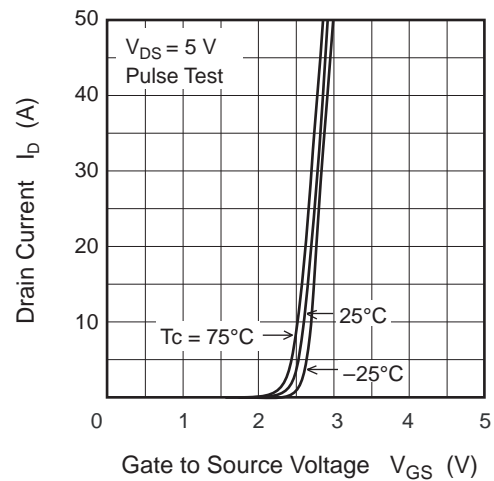
Maximum Safe Operation Area



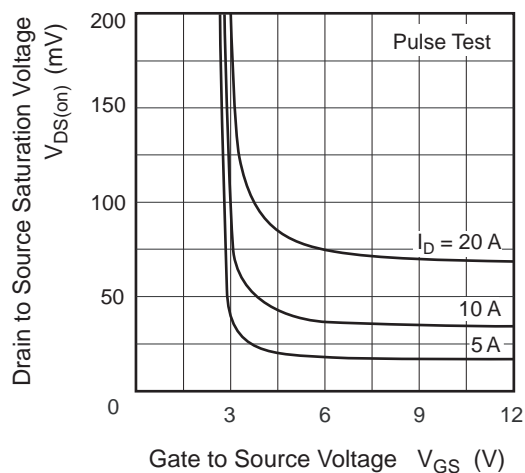
Typical Output Characteristics



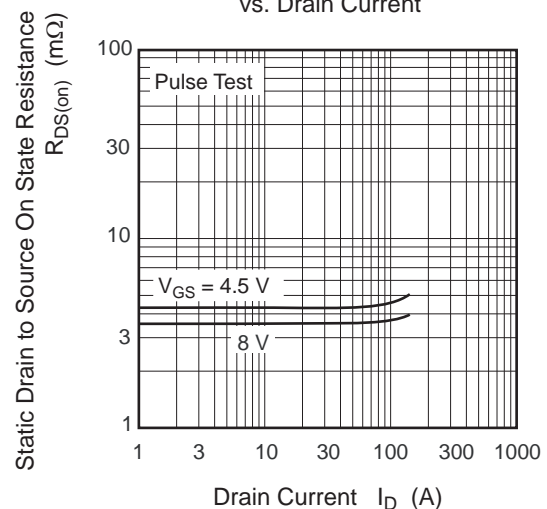
Typical Transfer Characteristics



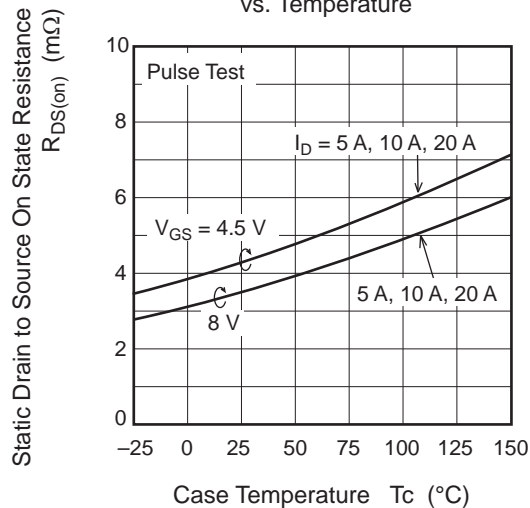
Drain to Source Saturation Voltage vs. Gate to Source Voltage



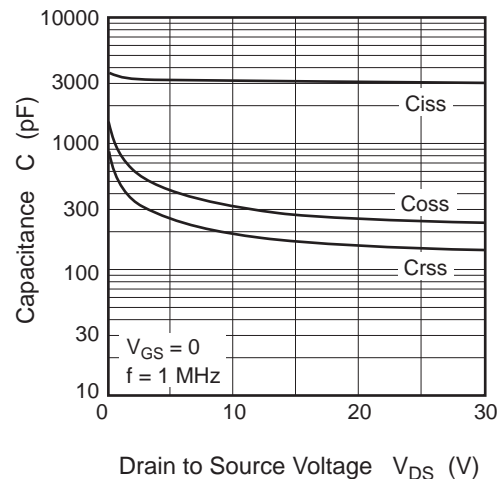
Static Drain to Source On State Resistance vs. Drain Current



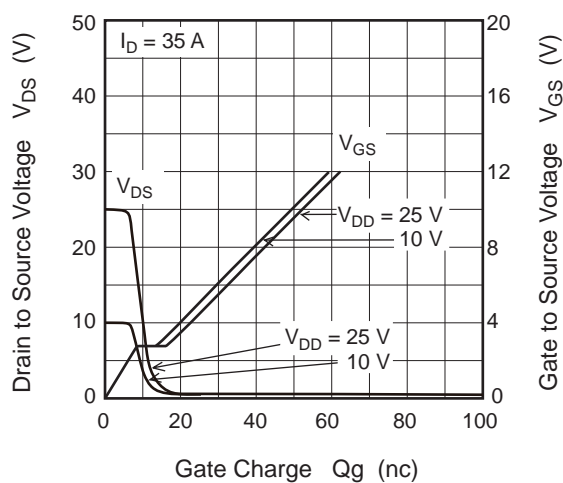
Static Drain to Source On State Resistance vs. Temperature



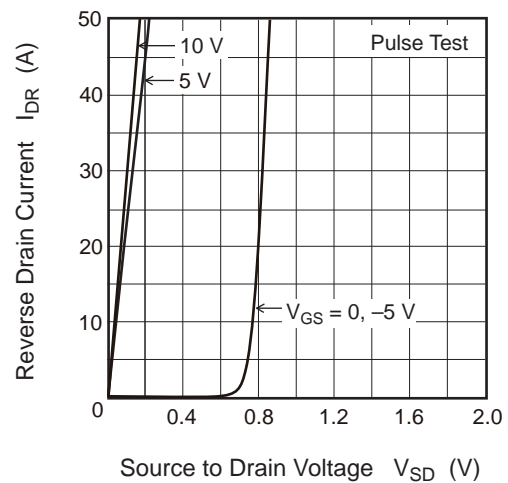
Typical Capacitance vs. Drain to Source Voltage



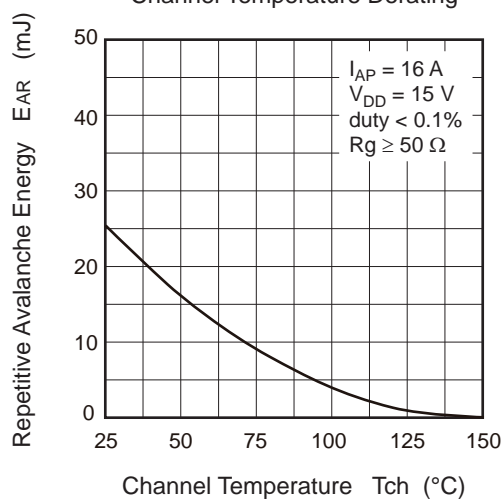
Dynamic Input Characteristics



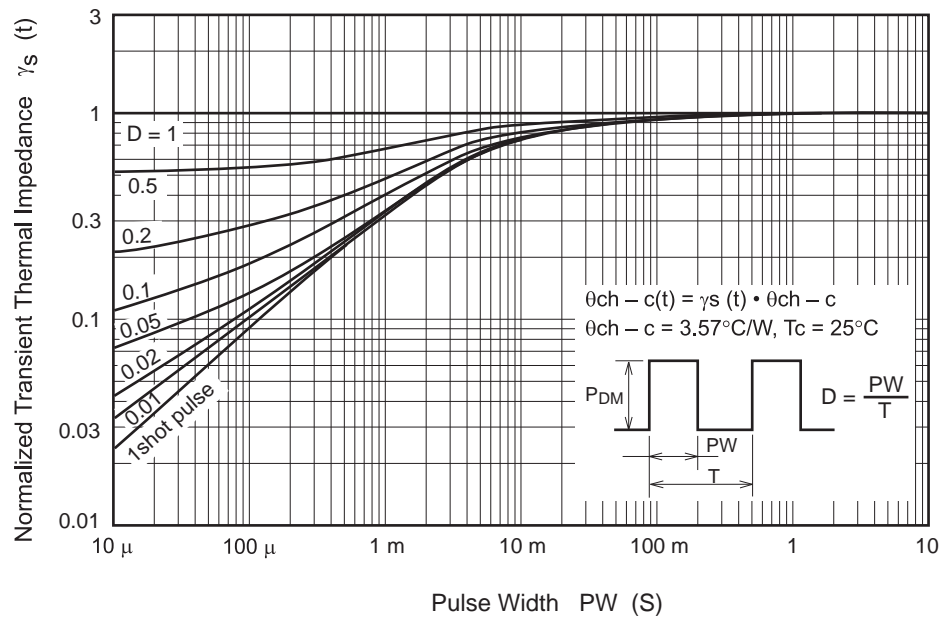
Reverse Drain Current vs. Source to Drain Voltage



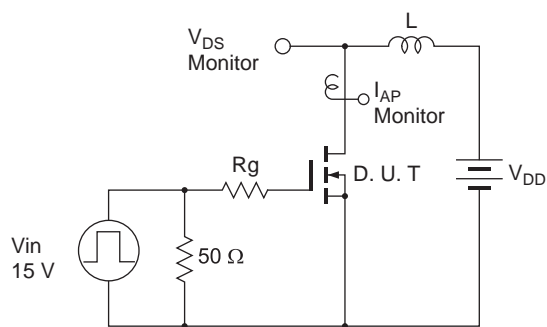
Maximum Avalanche Energy vs. Channel Temperature Derating



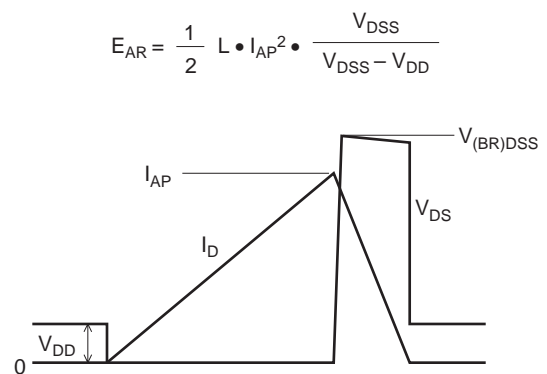
Normalized Transient Thermal Impedance vs. Pulse Width



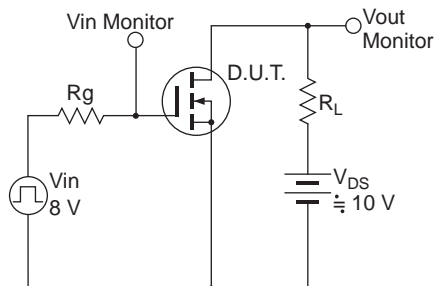
Avalanche Test Circuit



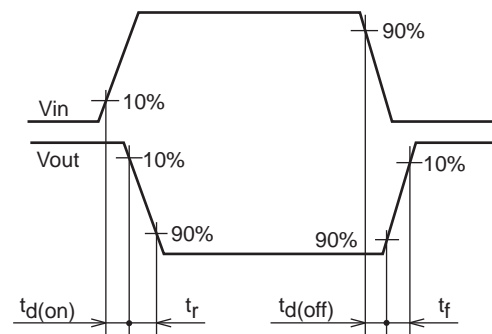
Avalanche Waveform



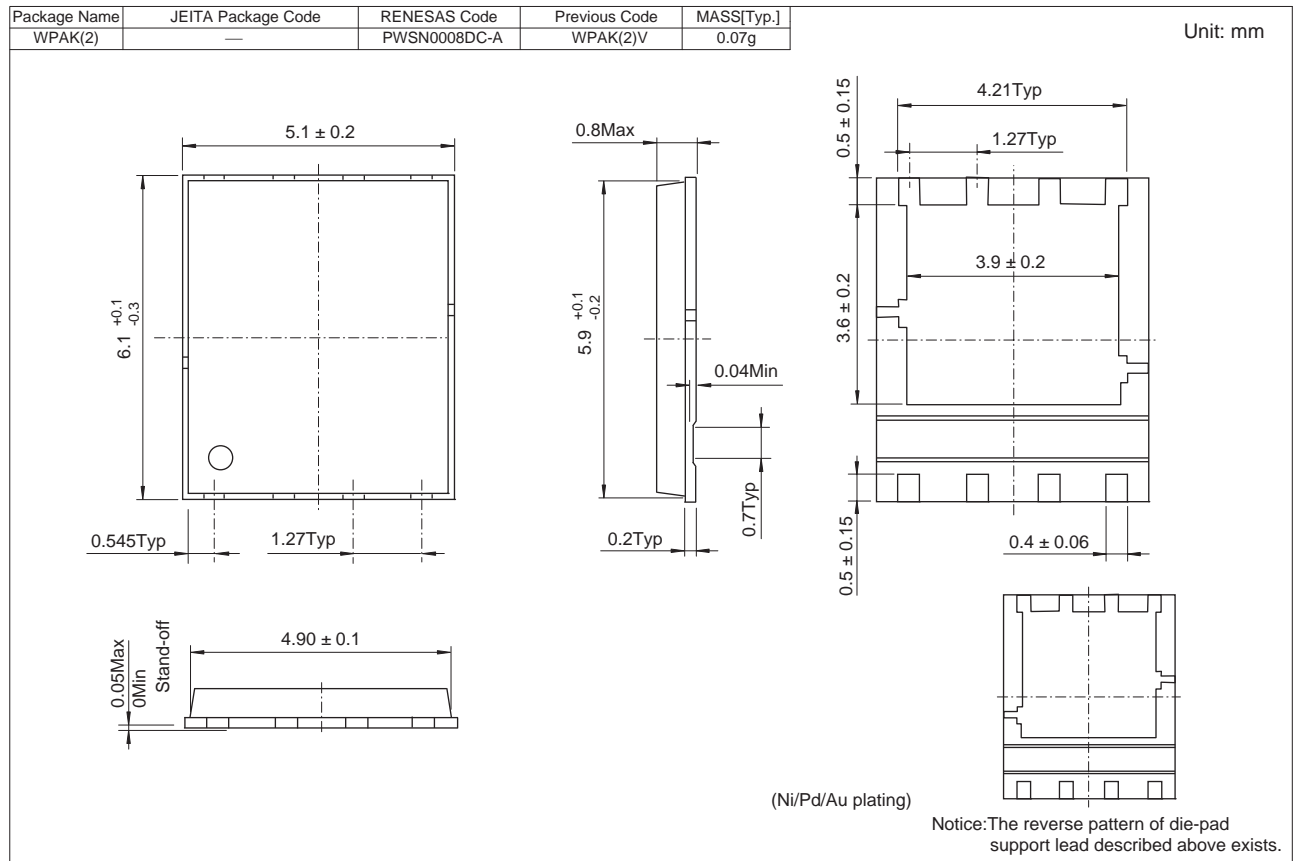
Switching Time Test Circuit



Switching Time Waveform



Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RJK03E9DPA-00-J53	3000 pcs	Taping

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